Remarks

Claims 1-36 have been cancelled without prejudice in view of the restriction requirement made final by the Examiner. These claim may be filed in a divisional application.

Claims 39 and 42 have been amended for purposes of clarification and obviating the objections made in the Office Action. In claim 42, a comma has been placed after glass, and the composition of the electron-transporting layer has been provided which is based on the specification at page 13, lines 23-27.

The rejection of claims 37 and 42 under 35 U.S.C. 112, second paragraph, is also deemed obviated by the amendment of the claims, cancellation of claim 37, and presentation of new claims 43 and 44.

Claim 43 has been added for purposes of clarification, thereby indicating how the adhesive interacts and surrounds the electronic system which includes cathode, anode and one or more organic layers between the anode and the cathode. The adhesive basically forms a perimeter around this multilayer construction. This is illustrated clearly in Fig. 3.

Claim 44 has been added to provide antecedent basis for claim 42, indicating specific organic layers which are between the anode and the cathode.

Reconsideration is respectfully requested of the rejection of the pending claims under 35 U.S.C. 102 as allegedly anticipated by Ito, U.S. 5,652,067.

The Ito patent describes a different organic electronic or electroluminescent device as shown in Fig. 1 and described at column 6. Fig. 1 and column 6 describes such device where an anode is placed on top of a substrate. The various layers, cathode and a sealing layer are formed in such a way that the electronic layers and the cathode are covered by the sealing layer. The anode does not appear to be covered by the sealing layer. The adhesive then is used over the sealing layer to cover the entire device. This construction in turn may be further protected with a surface protective member **9** of Fig. 1. In contrast, Fig. 3 of the present invention illustrates the invention as claimed in new claim 43 where the adhesive is placed on top of the substrate, the adhesive having a pattern structure to surround the OLED elements 16. A top sealing layer is

placed at the top of the construction which fits onto the adhesive and seals the adhesive with the substrate. The OLED elements are inside of the adhesive. This type of construction is not taught in Ito.

In view thereof, the rejection should be withdrawn.

A prompt and favorable reply is earnestly solicited.

Respectfully submitted,

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